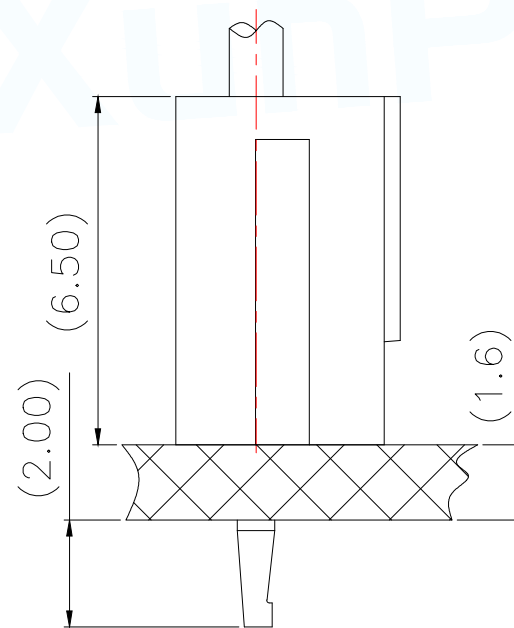
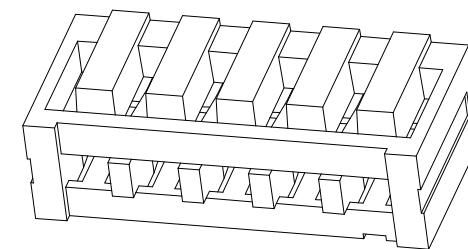


PART NO	PIN	A	B
WAFER-SCN2.5-2PJK	2	2.50	6.5
WAFER-SCN2.5-3PJK	3	5.00	9.0
WAFER-SCN2.5-4PJK	4	7.50	11.5
WAFER-SCN2.5-5PJK	5	10.00	14.0
WAFER-SCN2.5-6PJK	6	12.50	16.5
WAFER-SCN2.5-7PJK	7	15.00	19.0
WAFER-SCN2.5-8PJK	8	17.50	21.5
WAFER-SCN2.5-9PJK	9	20.00	24.0
WAFER-SCN2.5-10PJK	10	22.50	26.5
WAFER-SCN2.5-11PJK	11	25.00	29.0
WAFER-SCN2.5-12PJK	12	27.50	31.5
WAFER-SCN2.5-13PJK	13	30.00	34.0
WAFER-SCN2.5-14PJK	14	32.50	36.5
WAFER-SCN2.5-15PJK	15	35.00	39.0
WAFER-SCN2.5-16PJK	16	37.50	41.5



Assembly View (DIM FYI)



技术指标(Technical Index):

- 1.温度范围(Temperature range): $-25^{\circ}\text{C}\sim+85^{\circ}\text{C}$.
- 2.额定电压(Rated voltage):250V AC,DC.
- 3.耐电压(Withstanding Voltage):1000V AC/minute.
- 4.接触电阻(Contact resistance): $\leq 20\text{m}\Omega$.
- 5.绝缘电阻(Insulation resistance): $\geq 1000\text{M}\Omega$.
- 6.额定电流(Rated Current):2.5A AC,DC.

材料:

- 1.塑胶:PA66 白色

MANUFACTURE DWG		 东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co.,Ltd	
UNLESS OTHERWISE SPECIFIED TOLERANCES		TITLE: SCN2.5 WTB直插板款式	
DECIMALS:	ANGLES:	PAR	WAFER-SCN2.5-NPJK
X.: ± 0.50	$\pm 1^{\circ}$	DWN	Lucas
X.X: ± 0.20		CHKD	Ethan
X.XX: ± 0.10		APVD	Jacob
CUSTOMER COPY		SCALE:1:1	UNIT:MM
		SIZE:A4	SHEET:1F1
			REV:A